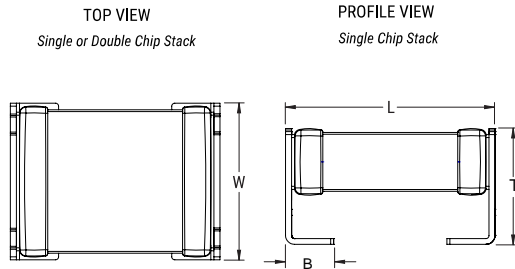


KPS SMD Comm X7R, Ceramic, 3.3 uF, 10%, 100 VDC, X7R, 2220-1



Dimensions	
L	6mm +/-0.5mm
W	5mm +/-0.5mm
T	3.5mm +/-0.30mm
B	1.6mm +/-0.3mm

Packaging Specifications	
Packaging:	T&R, 180mm, Plastic Tape
Packaging Quantity:	300

General Information	
Series:	KPS SMD Comm X7R
Style:	Stacked Chip
Description:	SMD, MLCC, Stacked, Single Chip, Temperature Stable
Features:	Temperature Stable
RoHS:	Yes
Termination:	Tin
AEC-Q200:	No
Component Weight:	410 mg
Chip Size:	2220-1
Shelf Life:	78 Weeks
MSL:	1

Specifications	
Capacitance:	3.3 uF
Measurement Condition:	1 kHz 1.0Vrms
Capacitance Tolerance:	10%
Voltage DC:	100 VDC
Dielectric Withstanding Voltage:	250 VDC
Temperature Range:	-55/+125°C
Temperature Coefficient:	X7R
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC):	15%, 1kHz 1.0Vrms
Dissipation Factor:	2.5% 1 kHz 1.0Vrms
Aging Rate:	3% Loss/Decade Hour: Referee Time is 1000 Hours
Insulation Resistance:	303 MOhms

Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute - and we specifically disclaim - any warranty concerning suitability for a specific customer application or use. This Information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this Information or otherwise provided by us with reference to the use of our products is given gratis, and we assume no obligation or liability for the advice given or results obtained.